

SPECIFICATION SHEET

SMD FAST RECOVERY BRIDGE RECTIFER RABS SERIES

SPECIFICATION SHEET NO.	S0430 – RABS8S000RABS8			
ORIGINAL MFG/PART NO.	MDD Diodes/RABS8			
NEXTGEN PART CODE	RABS8S000RABS8 Indicate This Code For RFQ /Order			
DATE	Apr. 30, 2025			
REVISION	A3 Updated With Most Recent Data			
DESCRIPTION AND	SMD Glass Passivated Fas	st Recovery Bridge Rectifiers, RABS Series, 4 Pads		
MAIN PARAMETRICS	Repetitive Peak Reverse Voltage: 800V Max. Forward Rectified Current 1.0A Max. Operating Temp. Range -55°C ~+150°C Package in Tape/Reel, 5000pcs/Reel RoHS/RoHS III compliant, RoHS Annex III lead Exemption (Exempt per RoHS EU 2015/863) and Halogen Free (HF)			
CUSTOMER				
CUSTOMER PART NUMBER				
CROSS REF. PART NUMBER				
МЕМО				

VENDOR APPROVE

Issued/Checked/Approved







Effective Date: Apr. 30, 2025

CUSTOMER APPROVE

NextGen Components, Inc.

Date:



SMD FAST RECOVERY BRIDGE RECTIFER RABS SERIES

MAIN FEATURE

- Glass Passivated Chip Junction
- · Reliable Low-cost Construction Utilizing Molded Plastic Technique
- High Temperature Soldering Guaranteed: 260°C/10 Seconds At 5 Lbs., (2.3kg) Tension
- High Surge Current Capability
- Small Size, Simple Installation
- Surface Mount Package Ideally Suited For Automatic Insertion
- Leads Solderable Per MIL-STD-202 Method 208
- · Meet MSL 1 Requirement
- · Cross Competitors Parts and More.
- RoHS/RoHS III compliant, RoHS Annex III lead Exemption (Exempt per RoHS EU 2015/863) and Halogen Free (HF)



Image shown is a representation only. Exact specifications should be obtained from the product dimension.







APPLICATION

For Printed Circuit Board

ELECTRICAL CHARACTERISTICS

- See Page 5 $^{\sim}$ Page 6 For Different Part Code.
- All Products Parameters are Subject To NextGen Components' Final Confirmation.



PART CODE: **RABS8S000RABS8**SMD FAST RECOVERY BRIDGE RECTIFER RABS SERIES

HOW TO ORDER

Please Follow Up Part Code Guide And Indicate NextGen Part Code RABS8S000RABS8 For RFQ and Order.

PART CODE GUIDE

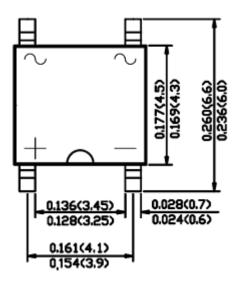


CODE	NAME	KEY SPECIFICATION OPTION
RABS	Product Series Code	SMD Glass Passivated Fast Recovery Bridge Rectifiers, Case ABS, 4 Pads
8	Repetitive Peak Reverse Voltage Code	2: 200V Max.; 4: 400V Max.; 6: 600V Max. 8: 800V Max. 10: 1000V Max.
S000	Internal Control Code	Letter or Digits (A~Z, a~z or 0~9)
RABS8	Marking Code	Marking "RABS8"
xx	Special/Custom Parameters Code	Letter or Digits (A~Z, a~z or 0~9) for Special Parametric; Blank: N/A

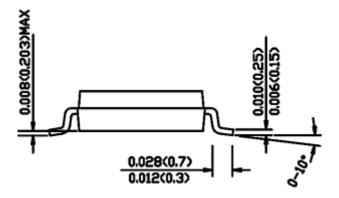


DIMENSION - Unit: mm, Case ABS, Inch/mm

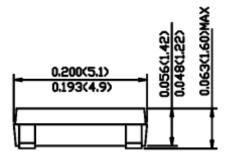
Top View



Side View



Side View

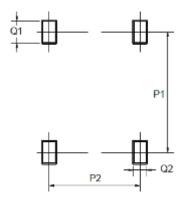


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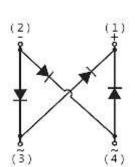


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Recommend Pad Layout - Tolerance: ±0.05mm



Symbol	Min. (mm)	
P1	5.72	
P2	4.00	
Q1	1.00	
Q2	0.90	



Circuit Diagram

MECHANICAL CHARACTERISTICS

CASE	FLAMMABILITY	TERMINALS	MARKING
	RATING		
JEDEC ABS molded plastic	UL 94V-0	Solder plated, solderable per MIL-STD-750,Method 2026	See Marking list For different part
bouy		WIL-31D-730,Wethou 2020	code

ABSOLUTE MAX. RATING & CHARACTERISTICS - TA=25°C unless otherwise specified, For Reference Only

PARAMETER		SYMBOLS	VALUE	UNITS
Max. Average Forward	On Glass-epoxy P.C.B.(Note 3)	. IF(AV)	0.8	Α
Rectified Current	On Aluminum Substrate (Note 4)	II (AV)	1.0	
Max. DC Reverse Current	TA = 25 °C	lR	5	μΑ
Rated DC Blocking Voltage	TA=100 °C	IN.	500	
Typical Thermal Resistance (Note 3)		Rejl	25	90/14/
		ROJA	75	°C/W
Maximum Reverse Recovery Time (Note 4)		trr	500	ns
Operating Temperature Range		ιT	-55 ~+ 150	°C
Storage Temperature Range		TSTG	-55 ~ +150	°C



SMD FAST RECOVERY BRIDGE RECTIFER RABS SERIES

ELECTRICAL PARAMETERS – FOR DIFFERENT PART CODE- Ta = 25°C

PART CODE	MAX. REPETITIVE PEAK REVERSE VOLTAGE	MAX. RMS VOLTAGE	MAX. BLOCKING VOLTAGE	PEAK FORWARD SURGE CURRENT, 8.3MS SINGLE HALF SINE- WAVE SUPERIMPOSED ON RATED LOAD	MAX. INSTANTANEOUS FORWARD VOLTAGE DROP PER LEG @0.4A	MARKING LIST
	VRRM	VRMS	VDC	IFSM	VF	
	V	V	V	А	V	
RABS2S000RABS2	200	140	200	30	1.30	RABS2
RABS4S000RABS4	400	280	400	30	1.30	RABS4
RABS6S000RABS6	600	420	600	30	1.30	RABS6
RABS8S000RABS8	800	560	800	30	1.30	RABS8
RABS10S0RABS10	1000	700	1000	30	1.30	RABS10

Note

- 1. Ratings at 25 C ambient temperature unless otherwise specified.
- 2. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.
- 3. On glass epoxy PCB mounted on 0.05*0.05" (1.3*1.3mm) pads
- 4. On aluminum substrate PCB with on area of 0.80*0.8" (20*20mm) mounted on 0.05*0.05" (1.3*1.3mm) solder pads
- 5. Thermal resistance form junction to ambient and junction to lead mounted on P.C.B. with 0.2X0.2" (5X5mm) copper pads.
- 6. Reverse recovery condition IF=0.5A,IR=1.0A,Irr=0.25A.



SMD FAST RECOVERY BRIDGE RECTIFER RABS SERIES

RATINGS AND CHARACTERISTICS CURVES- For Reference Only, Ta=25°C Unless Otherwise Specified.

FIG.1 FORWARD DERATING CURVE

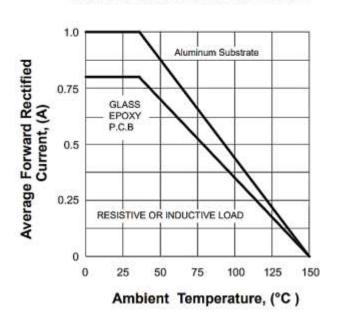
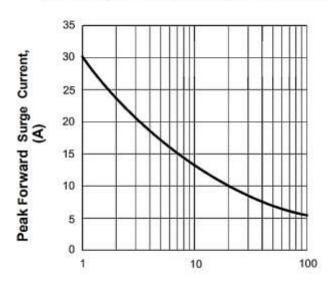


FIG.2 PEAK FORWARD SURGE CURRENT



Number Of Cycles At 60Hz

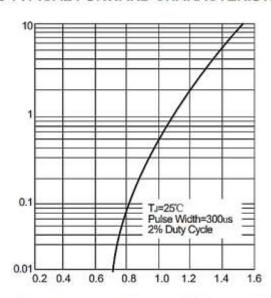


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RATINGS AND CHARACTERISTICS CURVES- For Reference Only, Ta=25°C Unless Otherwise Specified.

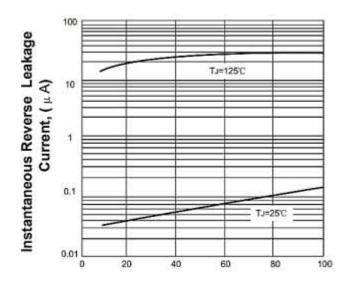
FIG.3 TYPICAL FORWARD CHARACTERISTICS





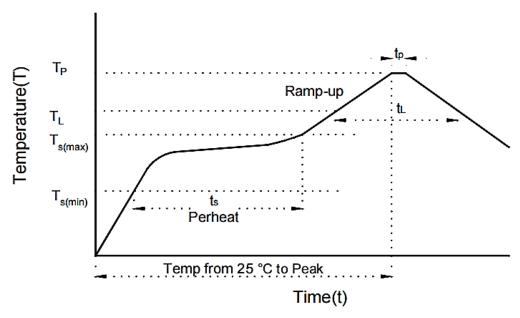
Instantaneous Forward Voltage, (V)

FIG.4 TYPICAL REVERSE CHARACTERISTICS



Percent Of Rated Peak Reverse Voltage, %

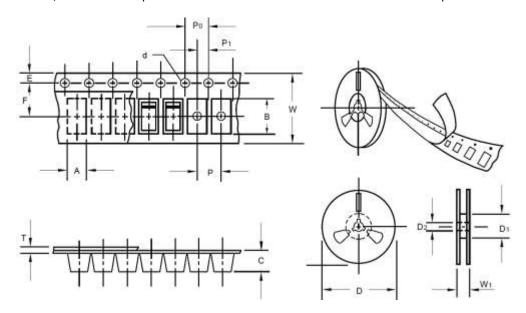
SUGGESTED REFLOW PROFILE - For Reference Only



PROFILE FEATURE		PB-FREE ASSEMBLY
Average Ramp-up Rate (T _L Max to T _p)		3°C/second Max
Preheat Temperature Min (T _s Min.)		150°C
	Temperature Max (T _s Max.)	200°C
	Time (t _s Min. to t _s Max.)	60 ~ 180 seconds
Time maintained above	Temperature (T _L)	217°C
	Time (t _L)	60 ~ 150 seconds
Peak/Classification Temperature (T _p)		260 °C
Time within 5°C of actual Peak Temperature (t _p)		10 seconds Max.
Ramp-down Rate		6 °C /Second Max.
Time 25 °C to Peak Temperature		8 Minutes Max.
Suggest reflow times		3 Times Max.

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TAPE/REEL - Unit: mm, All Devices are packed in accordance with EIA standard RS-481-A and specifications



ITEM	SYMBOL	TOLERANCE	ABS	
Carrier width	А	0.1	2.8	
Carrier Length	В	0.1	5.33	
Carrier Depth	С	0.1	2.36	
Sprocket hole	d	0.05	1.5	
7"Reel outside diameter	D	2	330	
7"Reel inner diameter	D1	Min.	50	
Feed hole diameter	D2	0.5	13	
Sprocket hole position	E	0.1	1.75	
Punch hole position	F	0.1	5.5	
Punch hole pitch	Р	0.1	4	
Sprocket hole pitch	Р0	0.1	4	
Embossment center	P1	0.1	2	
Overall tape thickness	Т	0.1	0.28	
Tape width	W	0.3	12	
Reel width	W1	1	18	
Qty. Per Reel (pcs)	5000			

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IMPORTANT NOTES AND DISCLAIMER

- ROHS COMPLIANCE: The levels of RoHS restricted materials in this product are below the maximum
 concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an
 exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for
 this product can be obtained can be obtained at Download Center.
- REACH COMPLIANCE: REACH substances of high concern (SVHCs) information is available for this product.
 Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained at Download Center.
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 conditions, unless otherwise noted. Product performance may not be indicated by the Electrical
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